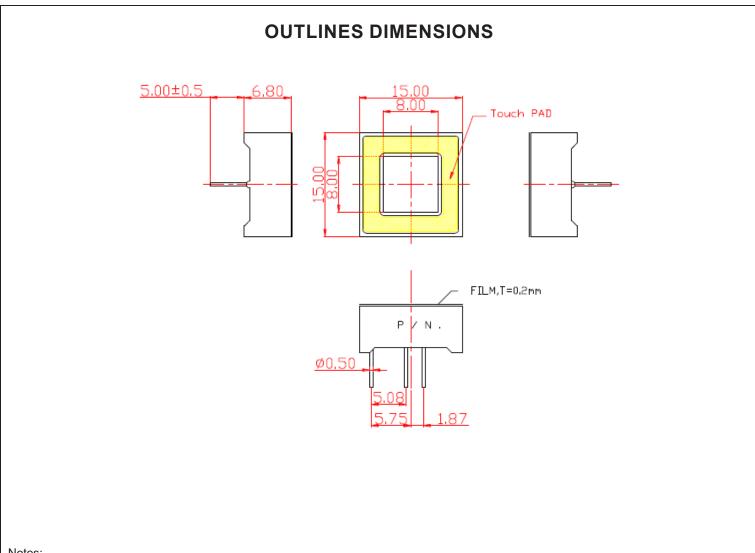


## **SPECIFICATIONS**

# CTD5959GT2WB



#### Notes:

- 1. All Dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25mm (0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Description	
CTD5959GT2WB	InGaN	Green	White	Touch Display	



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com



## **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Power Dissipation	Pb	120	mW	
Continuous Forward Current (Per Dice)	lF	30	mA	
Peak Current (Per Dice)	lfP	100	mA	
Reverse Voltage (Per Dice)	VR	5	V	
Operating Temperature Range	Topr	-25~+85	°C	
Storage Temperature Range	Тѕтс	-25~+85	°C	
Hand Soldering Condition: 360 °C/ 3sec				

## **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

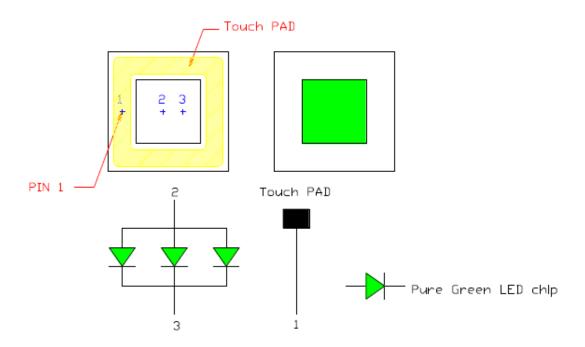
Deremeter	Symbol	Test Condition	Value			Linit
Parameter			Min	Тур	Max	Unit
Luminous Intensity	lv	I <sub>F</sub> = 20mA	-	90	-	mcd
Forward Voltage	VF	I <sub>F</sub> = 20mA	ı	3.2	4.0	V
Reverse Leakage Current	lR	V <sub>R</sub> = 5V	-	-	10	μΑ
Dominant Wavelength	λD	I⊧ = 20mA	-	525	-	nm
Spectral Radiation Bandwidth	Δλ	I⊧ = 20mA	-	30	-	nm



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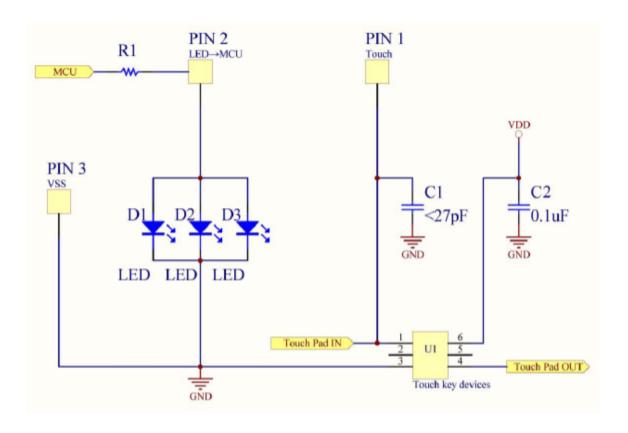


## **INTERNAL CIRCUIT DIAGRAMS**





## **TYPICAL APPLICATION CIRCUITS**



# Internal Components are not customer accessible





### **OPTICAL CHARACTERISTIC CURVES**

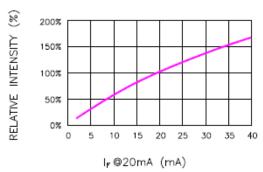


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

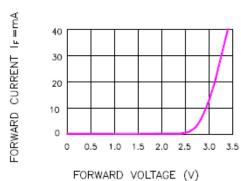
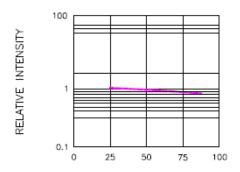
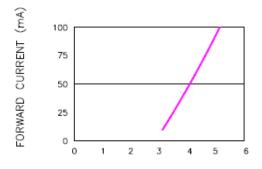


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE



LEAD TEMPERATURE(\*C) Fig.3 RELATIVE INTENSITY VS.LEAD TEMPERATURE (PULSED 20 mA; 300us PULSE,10ms PERIOD)



FORWARD VOLTAGE(V) Fig.4 PEAK FORWARD VOLTAGE VS.FORWARD(100us TEST PULSE, 1% DUTY CYCLE)

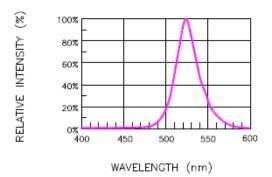
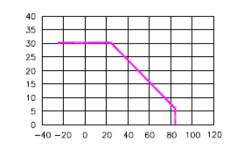


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH



AMBIENT TEMPERATURE (TA)-\*C Fig.6 MAX. ALLOWABLE DC CURRENT

VS. AMBIENT TEMPERATURE

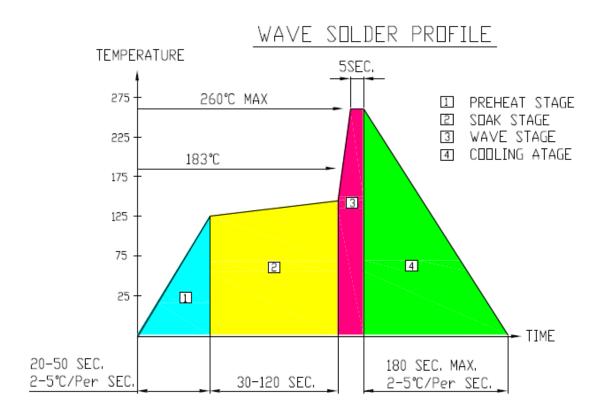
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CURRENT-mA

2



### **SOLDERING CHARACTERISTICS**



#### **NOTES**

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2. Peak wave soldering temperature between 245°C ~ 225°C for 3 sec (5 sec max)
- 3. No more than one wave soldering pass

#### SOLDERING IRON

 Basic spec is ≤4 sec when 260°C. If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C

### **REWORK**

- 1. Customer must finish rework within 3 sec under 350°C
- 2. The head of soldering iron cannot touch copper foil

